



Welcome to [E-XFL.COM](https://www.e-xfl.com)

Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

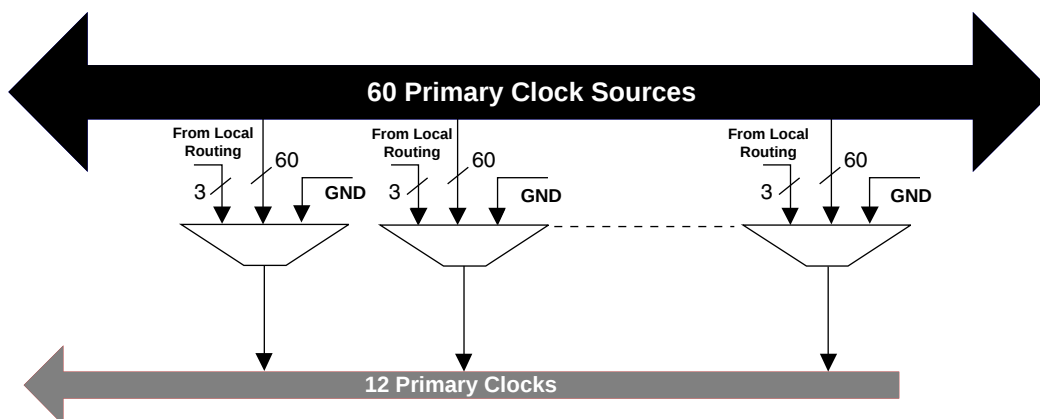
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	10000
Number of Logic Elements/Cells	40000
Total RAM Bits	4075520
Number of I/O	604
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1152-BBGA, FCBGA
Supplier Device Package	1152-FCBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfscm3ga40ep1-6ff1152c

Figure 2-6. Per Quadrant Clock Selection

Note: GND is available to switch off the network.

Secondary Clocks

In addition to the primary clock network and edge clocks the LatticeSC devices also contain a secondary clock network. Built of X6 style routing elements this secondary clock network is ideal for routing slower speed clock and control signals throughout the device preserving high-speed clock networks for the most timing critical signals.

Edge Clocks

LatticeSC devices have a number of high-speed edge clocks that are intended for use with the PIOs in the implementation of high-speed interfaces. There are eight edge clocks per bank for the top and bottom of the device. The left and right sides have eight edge clocks per side for both banks located on that side. Figure 2-7 shows the arrangement of edge clocks.

Edge clock resources can be driven from a variety of sources. Edge clock resources can be driven from:

- Edge clock PIOs in the same bank
- Primary clock PIOs in the same bank
- Routing
- Adjacent PLLs and DLLs
- ELSR output from the clock divider

Table 2-9. Supported Input Standards

Input Standard	V _{REF} (Nom.)	V _{CCIO} ¹ (Nom.)	On-chip Termination
Single Ended Interfaces			
LVTTL33 ³	—	3.3	None
LVC MOS 33, 25, 18, 15, 12 ³	—	3.3/2.5/1.8/1.5/1.2	None
PCI33, PCIX33, AGP1X33 ³	—	3.3	None
PCIX15	0.75	1.5 ²	None / V _{CCIO} / 2: 50, 60/ V _{TT} : 60, 75, 120, 210
AGP2X33	1.32	—	None
HSTL18_I, II	0.9	1.8 ²	None / V _{CCIO} / 2: 50, 60/ V _{TT} : 60, 75, 120, 210
HSTL18_III, IV	1.08	1.8 ²	None / V _{CCIO} : 50
HSTL15_I, II	0.75	1.5 ²	None / V _{CCIO} / 2: 50, 60/ V _{TT} : 60, 75, 120, 210
HSTL15_III, IV	0.9	1.5 ²	None / V _{CCIO} : 50
SSTL33_I, II	1.5	3.3	None
SSTL25_I, II	1.25	2.5 ²	None / V _{CCIO} / 2: 50, 60/ V _{TT} : 60, 75, 120, 210
SSTL18_I, II	0.9	1.8 ²	None / V _{CCIO} / 2: 50, 60/ V _{TT} : 60, 75, 120, 210
GTL+, GTL	1.0 / 0.8	1.5 / 1.2 ²	None / V _{CCIO} : 50
Differential Interfaces			
SSTL18D_I, II	—	1.8 ²	None / Diff: 120, 150, 220, 420/ Diff to V _{CMT} : 120, 150, 220, 420 / V _{CCIO} / 2: 50, 60/ V _{TT} : 60, 75, 120, 210
SSTL25D_I, II	—	2.5 ²	None / Diff: 120, 150, 220, 420/ Diff to V _{CMT} : 120, 150, 220, 420 / V _{CCIO} / 2: 50, 60/ V _{TT} : 60, 75, 120, 210
SSTL33D_I, II	—	3.3	None
HSTL15D_I, II	—	1.5 ²	None / Diff: 120, 150, 220, 420/ Diff to V _{CMT} : 120, 150, 220, 420 / V _{CCIO} / 2: 50, 60/ V _{TT} : 60, 75, 120, 210
HSTL18D_I, II	—	1.8 ²	None / Diff: 120, 150, 220, 420/ Diff to V _{CMT} : 120, 150, 220, 420 / V _{CCIO} / 2: 50, 60/ V _{TT} : 60, 75, 120, 210
LVDS	—	—	None / Diff: 120, 150, 220, 240/ Diff to V _{CMT} : 120, 150, 220, 240
Mini-LVDS	—	—	None / Diff: 120, 150 / Diff to V _{CMT} : 120, 150
BLVDS25	—	—	None
MLVDS25	—	—	None
RSDS	—	—	None / Diff: 120, 150, 220, 240/ Diff to V _{CMT} : 120, 150, 220, 240
LVPECL33	—	≤2.5	None / Diff: 120, 150, 220, 240/ Diff to V _{CMT} : 120, 150, 220, 240

1. When not specified V_{CCIO} can be set anywhere in the valid operating range.

2. V_{CCIO} needed for on-chip termination to V_{CCIO}/2 or V_{CCIO} only. V_{CCIO} is not specified for off-chip termination or V_{TT} termination.

3. All ratioed input buffers and dedicated pin input buffers include hysteresis with a typical value of 50mV.

PURESPEED I/O Differential Electrical Characteristics**LVDS****Over Recommended Operating Conditions**

Parameter Symbol	Parameter Description	Test Conditions	Min.	Typ.	Max.	Units
V_{INP}, V_{INM}	Input voltage		0	—	2.4	V
V_{THD}	Differential input threshold ($Q-\bar{Q}$)		+/-100	—	—	mV
V_{CM}	Input common mode voltage		0.05	1.2	2.35	V
I_{IN}	Input current	Power on or power off	—	—	+/-10	μ A
V_{OH}	Output high voltage for V_{OP} or V_{OM}	$R_T = 100 \text{ Ohm}$	—	1.38	1.60	V
V_{OL}	Output low voltage for V_{OP} or V_{OM}	$R_T = 100 \text{ Ohm}$	0.9V	1.03	—	V
V_{OD}	Output voltage differential	$(V_{OP} - V_{OM}), R_T = 100 \text{ Ohm}$	250	350	450	mV
ΔV_{OD}	Change in V_{OD} between high and low		—	—	50	mV
V_{OS}	Output voltage offset	$(V_{OP} - V_{OM})/2, R_T = 100 \text{ Ohm}$	1.125	1.20	1.375	V
ΔV_{OS}	Change in V_{OS} between H and L		—	—	50	mV
I_{SAB}	Output short circuit current	$V_{OD} = 0V$ Driver outputs shorted	—	—	12	mA
T_R, T_F	Output rise and fall times, 20% to 80%	—	—	500	ps	T_R, T_F

Notes:

1. Data is for 3.5mA differential current drive. Other differential driver current options are available.
2. If the low power mode of the input buffer is used, the minimum V_{CM} is 600 mV.

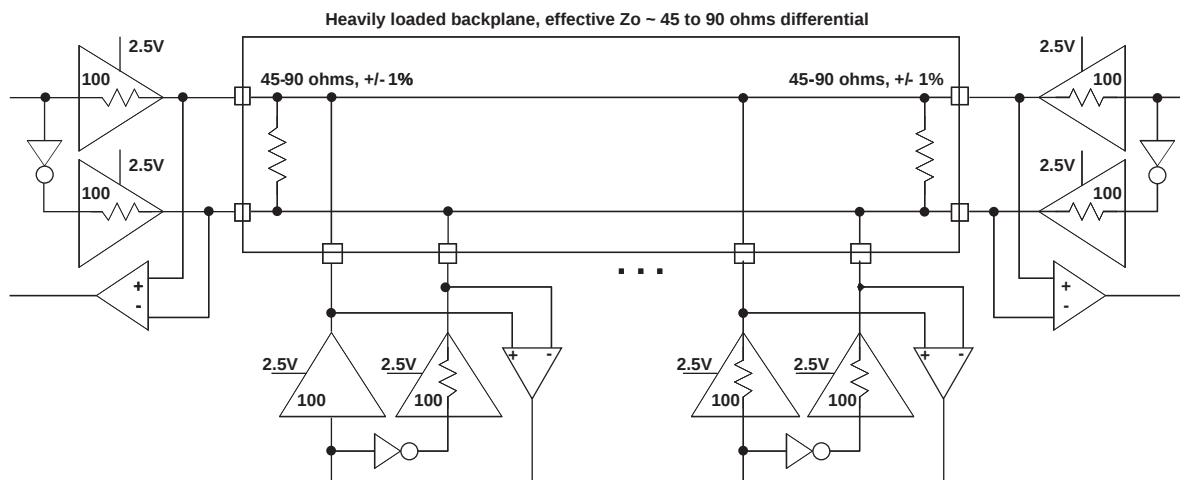
Mini-LVDS**Over Recommended Operating Conditions**

Parameter Symbol	Description	Min.	Typ.	Max.	Units
Z_O	Single-ended PCB trace impedance	30	50	75	ohms
R_T	Differential termination resistance	60	100	150	ohms
V_{OD}	Output voltage, differential, $ V_{OP} - V_{OM} $	300	—	600	mV
V_{OS}	Output voltage, common mode, $ V_{OP} + V_{OM} /2$	1	1.2	1.4	V
ΔV_{OD}	Change in V_{OD} , between H and L	—	—	50	mV
ΔV_{ID}	Change in V_{OS} , between H and L	—	—	50	mV
V_{THD}	Input voltage, differential, $ V_{INP} - V_{INM} $	200	—	600	mV
V_{CM}	Input voltage, common mode, $ V_{INP} + V_{INM} /2$	$0.3+(V_{THD}/2)$	—	$2.1-(V_{THD}/2)$	
T_R, T_F	Output rise and fall times, 20% to 80%	—	—	500	ps
T_{ODUTY}	Output clock duty cycle	45	—	55	%
T_{IDUTY}	Input clock duty cycle	40	—	60	%

Note: Data is for 6mA differential current drive. Other differential driver current options are available.

BLVDS

The LatticeSC devices support BLVDS standard. This standard is emulated using controlled impedance complementary LVCMOS outputs in conjunction with a parallel external resistor across the driver outputs. BLVDS is intended for use when multi-drop and bi-directional multi-point differential signaling is required. The scheme shown in Figure 3-2 is one possible solution for bi-directional multi-point differential signals.

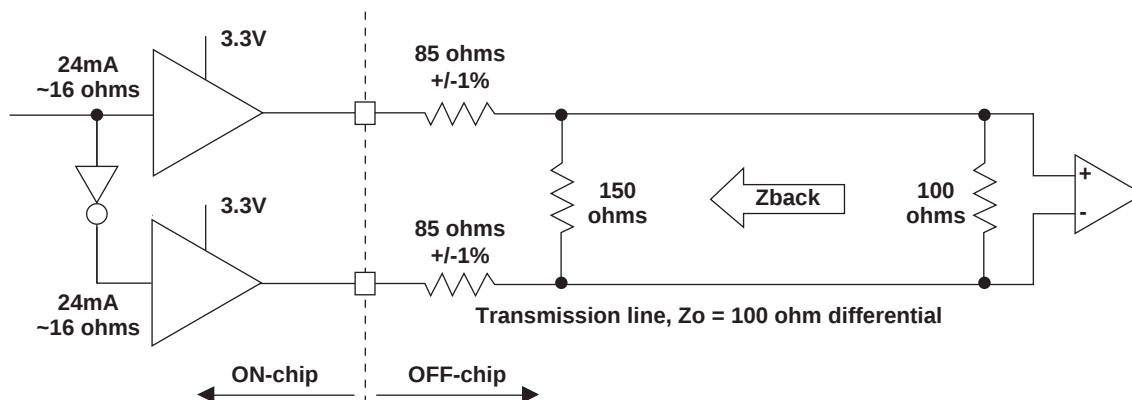
Figure 3-2. BLVDS Multi-point Output Example**Table 3-2. BLVDS DC Conditions¹****Over Recommended Operating Conditions**

Symbol	Description	Nominal		Units
		Zo = 45	Zo = 90	
Z _{OUT}	Output impedance	100	100	ohm
R _{TLEFT}	Left end termination	45	90	ohm
R _{TRIGHT}	Right end termination	45	90	ohm
V _{OH}	Output high voltage	1.375	1.48	V
V _{OL}	Output low voltage	1.125	1.02	V
V _{OD}	Output differential voltage	0.25	0.46	V
V _{CM}	Output common mode voltage	1.25	1.25	V
I _{DC}	DC output current	11.2	10.2	mA

1. For input buffer, see LVDS table.

LVPECL

The LatticeSC devices support differential LVPECL standard. This standard is emulated using controlled impedance complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The scheme shown in Figure 3-3 is one possible solution for point-to-point signals.

Figure 3-3. Differential LVPECL**Table 3-3. LVPECL DC Conditions¹****Over Recommended Operating Conditions**

Symbol	Description	Nominal	Units
Z_{OUT}	Output impedance	16	ohm
R_S	Driver series resistor	85	ohm
R_P	Driver parallel resistor	150	ohm
R_T	Receiver termination	100	ohm
V_{OH}	Output high voltage	2.03	V
V_{OL}	Output low voltage	1.27	V
V_{OD}	Output differential voltage	0.76	V
V_{CM}	Output common mode voltage	1.65	V
Z_{BACK}	Back impedance	86	ohm
I_{DC}	DC output current	12.6	mA

1. For input buffer, see LVDS table.

For further information on LVPECL, BLVDS, MLVDS and other differential interfaces please see details of additional technical documentation at the end of this data sheet.

On-die Differential Common Mode Termination

Symbol	Description	Min.	Typ.	Max.	Units
C_{CMT}	Capacitance V_{CMT} to GND	—	40	—	pF

LatticeSC/M Internal Timing Parameters¹

Over Recommended Commercial Operating Conditions at VCC = 1.2V +/- 5%

Parameter	Symbol	Description	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
PFU Logic Mode Timing									
t _{LUT4_PFU}	CTOF_DEL	LUT4 delay (A to D inputs to F output)	—	0.045	—	0.050	—	0.054	ns
t _{LUT5_PFU}	MTOOFX_DEL	LUT5 delay (inputs to output)	—	0.152	—	0.172	—	0.192	ns
t _{LSR_PFU}	LSR_DEL	Set/Reset to output (asynchronous)	—	0.378	—	0.426	—	0.474	ns
t _{SUM_PFU}	M_SET	Clock to Mux (M0,M1) input setup time	0.113	—	0.131	—	0.148	—	ns
t _{HM_PFU}	M_HLD	Clock to Mux (M0,M1) input hold time	-0.041	—	-0.046	—	-0.052	—	ns
t _{SUD_PFU}	DIN_SET	Clock to D input setup time	0.072	—	0.083	—	0.094	—	ns
t _{HD_PFU}	DIN_HLD	Clock to D input hold time	-0.028	—	-0.032	—	-0.035	—	ns
t _{CK2Q_PFU}	REG_DEL	Clock to Q delay, D-type register configuration	—	0.224	—	0.252	—	0.279	ns
t _{LE2Q_PFU}	LTCH_DEL	Clock to Q delay latch configuration	—	0.294	—	0.331	—	0.367	ns
t _{LD2Q_PFU}	TLTCH_DEL	D to Q throughput delay when latch is enabled	—	0.300	—	0.338	—	0.376	ns
PFU Memory Mode Timing									
t _{CORAM_PFU}	CLKTOF_DEL	Clock to Output	—	0.575	—	0.649	—	0.724	ns
t _{SUDATA_PFU}	DIN_SET	Data Setup Time	-0.024	—	-0.026	—	-0.027	—	ns
t _{HDATA_PFU}	DIN_HLD	Data Hold Time	0.075	—	0.084	—	0.094	—	ns
t _{SUADDR_PFU}	WAD_SET	Address Setup Time	-0.176	—	-0.196	—	-0.215	—	ns
t _{HADDR_PFU}	WAD_HLD	Address Hold Time	0.110	—	0.124	—	0.138	—	ns
t _{SUWREN_PFU}	WE_SET	Write/Read Enable Setup Time	0.014	—	0.019	—	0.024	—	ns
t _{HWREN_PFU}	WE_HLD	Write/Read Enable Hold Time	0.078	—	0.086	—	0.094	—	ns
PIC Timing									
PIO Input/Output Buffer Timing									
t _{IN_PIO}	IN_DEL	Input Buffer Delay(LVCMOS25)	—	0.578	—	0.661	—	0.744	ns
t _{OUT_PIO}	DOPADI_DEL	Output Buffer Delay(LVCMOS25)	—	2.712	—	3.027	—	3.395	ns
t _{SUI_PIO}	DIN_SET	Input Register Setup Time (Data Before Clock)	0.277	—	0.312	—	0.348	—	ns
t _{HI_PIO}	DIN_HLD	Input Register Hold Time (Data after Clock)	-0.267	—	-0.306	—	-0.345	—	ns
t _{COO_PIO}	CK_DEL	Output Register Clock to Output Delay	—	0.513	—	0.571	—	0.639	ns
t _{SUCE_PIO}	CE_SET	Input Register Clock Enable Setup Time	—	0.000	—	0.000	—	0.000	ns
t _{HCE_PIO}	CE_HLD	Input Register Clock Enable Hold Time	—	0.129	—	0.145	—	0.161	ns
t _{SULSR_PIO}	LSR_SET	Set/Reset Setup Time	0.057	—	0.060	—	0.063	—	ns
t _{HLSR_PIO}	LSR_HLD	Set/Reset Hold Time	-0.151	—	-0.159	—	-0.169	—	ns
t _{LE2Q_PIO}	CK_DEL	Input Register Clock to Q delay latch configuration	—	0.335	—	0.372	—	0.410	ns
t _{LD2Q_PIO}	DIN_DEL	Input Register D to Q throughput delay when latch is enabled	—	0.578	—	0.647	—	0.717	ns

LatticeSC/M sysCONFIG Port Timing (Continued)

Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
sysCONFIG Asynchronous Peripheral Configuration Mode				
t_{WRAP}	WRN, CS0N and CS1 Pulse Width	5	-	ns
t_{SAP}	D[7:0] Setup Time	1.5	-	ns
t_{RDYAP}	RDY Delay	—	8	ns
t_{BAP}	RDY Low	1	8	CCLK periods
t_{WR2AP}	Earliest WRN After RDY Goes High	0	—	ns
t_{DENAP}	RDN to D[7:0] Enable/Disable	—	7.5	ns
t_{DAP}	CCLK to DOUT	—	7.5	ns
sysCONFIG Slave Serial Configuration Mode				
t_{SSS}	DIN Setup Time	5.2	—	ns
t_{HSS}	DIN Hold Time	0	—	ns
t_{CHSS}	CCLK High Time	3.75	—	ns
t_{CLSS}	CCLK Low Time	3.75	—	ns
f_{CSS}	CCLK Frequency	—	150	MHz
t_{DSS}	CCLK to DOUT	—	7.5	ns
sysCONFIG Slave Parallel Configuration Mode				
t_{S1SP}	CS0N, CS1, WRN Setup Time	5.2	—	ns
t_{H1SP}	CS0N, CS1, WRN Hold Time	0	—	ns
t_{S2SP}	D[7:0] Setup Time	5.2	—	ns
t_{H2SP}	D[7:0] Hold Time	0	—	ns
t_{CHSP}	CCLK High Time	3.75	—	ns
t_{CL}	CCLK Low Time	3.75	—	ns
f_{CSP}	CCLK Frequency	—	150	MHz

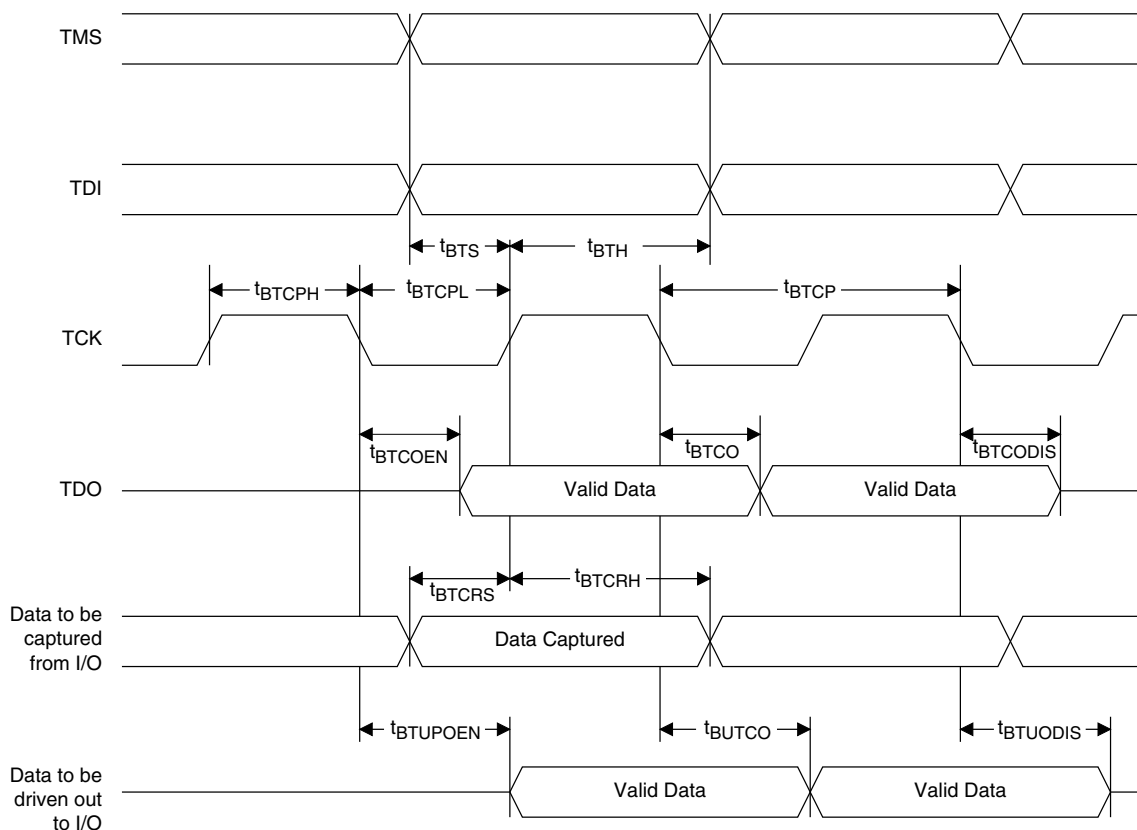
sysCONFIG MPI Port

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
$t_{MPICTRL_SET}$	MPI Control (MPCSTRBN, MPCWRN, MPCCLK, etc.) to MPCCLK Setup Time	4.9	—	5.2	—	5.5	—	ns
t_{MPIADR_SET}	MPI Address to MPCCLK Setup Time	3.9	—	4.2	—	4.5	—	ns
t_{MPIDAT_SET}	MPI Write Data to MPCCLK Setup Time	4.9	—	5.2	—	5.5	—	ns
$t_{MPIDPAR_SET}$	MPI Write Parity Data to MPCCLK Setup Time	3.9	—	4.2	—	4.5	—	ns
t_{MPI_HLD}	All Hold Times	0	—	0	—	0	—	ns
$t_{MPICTRL_DEL}$	MPCCLK to MPI Control (MPCTA, MPC-TEA, MPCRETRY)	—	5.6	—	6.7	—	8.7	ns
t_{MPIDAT_DEL}	MPCCLK to MPI Data	—	5.6	—	6.7	—	8.7	ns
$t_{MPIDPAR_DEL}$	MPCCLK to MPI Parity Data	—	4.9	—	5.7	—	7.7	ns
$f_{MPI_CLK_FRQ}$	MPCCLK Frequency	—	100	—	83	—	66	MHz

JTAG Port Timing Specifications

Over Recommended Operating Conditions

Symbol	Parameter	Min.	Max.	Units
f_{MAX}		—	25	MHz
t_{BTCP}	TCK [BSCAN] Clock Pulse Width	40	—	ns
t_{BTCPH}	TCK [BSCAN] Clock Pulse Width High	20	—	ns
t_{BTCPL}	TCK [BSCAN] Clock Pulse Width Low	20	—	ns
t_{BTS}	TCK [BSCAN] Setup Time	8	—	ns
t_{BTH}	TCK [BSCAN] Hold Time	10	—	ns
t_{BTRF}	TCK [BSCAN] Rise/Fall Time	50	—	mV/ns
t_{BTCO}	TAP Controller Falling Edge of Clock to Valid Output	—	10	ns
t_{BTCODIS}	TAP Controller Falling Edge of Clock to Valid Disable	—	10	ns
t_{BTCOEN}	TAP Controller Falling Edge of Clock to Valid Enable	—	10	ns
t_{BTCRS}	BSCAN Test Capture Register Setup Time	8	—	ns
t_{BTCRH}	BSCAN Test Capture Register Hold Time	10	—	ns
t_{BUTCO}	BSCAN Test Update Register, Falling Edge of Clock to Valid Output	—	25	ns
t_{BTUODIS}	BSCAN Test Update Register, Falling Edge of Clock to Valid Disable	—	25	ns
t_{BTUPOEN}	BSCAN Test Update Register, Falling Edge of Clock to Valid Enable	—	25	ns

Figure 3-14. JTAG Port Timing Waveforms

Signal Descriptions (Cont.)

Signal Name	I/O	Description
D[n:0]	I/O	In parallel configuration modes, D[7:0] receives configuration data, and each pin is pull-up enabled. For slave serial mode, D0 is the data input. D[7:3] is the output internal status for peripheral mode when RDN is low. D[7:0] is also the first byte of MPI data pins. In MPI configuration mode, MPI selectable data bus width from 8 and 16-bit. Driven by a bus master in a write transaction. Driven by MPI in a read transaction.
DP[m:0]	I/O	MPI selectable parity data bus width from 1, 2, and 3-bit DP[0] for D[7:0], DP[1] for D[15:8], and DP[2] for D[23:16].
BUSYN/RCLK/SCK	O	During configuration in peripheral mode, high on BUSYN indicates another byte can be written to the FPGA. If a read operation is done when the device is selected, the same status is also available on D[7] in asynchronous peripheral mode. During configuration in slave parallel mode, low on BUSYN inhibits the external host from sending new data. The output is used by slave parallel and master serial modes only for decompression. During configuration in master parallel and master byte modes, RCLK is a read clock output signal to an external memory. The RCLK frequency is the same as CCLK when used with uncompressed bit-streams. RCLK will be 1/8 the frequency of CCLK when the bitstream is compressed. During configuration in SPI modes, SCK is generated by the device and connected to the CLK input of the FLASH memory.
MPI Interface (Dedicated pin)		
MPI_IRQ_N	O	MPI Interrupt request active low signal is controlled by system bus interrupt controller and may be sourced from any bus error or MPI configuration error. It can be connected to one of MPC860 IRQ pins.
MPI Interface (User I/O if MPI is not used.)		
MPI_CS0N MPI_CS1	I	MPI chip select pins, active low on MPI_CS0N while active high on MPI_CS1. Both have to be active during the whole transfer data phase. During transfer address phase, both can be inactive so that the decoding for them from address can be slow. If they are active during address phase, one cycle can be saved for sync read.
MPI_CLK	I	This is the PowerPC bus clock. It can be a source of the clock for embedded system bus. If MPI_CLK is used as system bus clock, MPI will be set into sync mode by default. All of the operation on PowerPC side of MPI are synchronized to the rising edge of this clock.
MPI_TSIZE[1:0]	I	Driven by a bus master to indicate the data transfer size for the transaction. 01 for byte, 10 for half-word, and 00 for word.
MPI_WR_N	I	Driven high indicates that a read access is in progress. Driven low indicates that a write access is in process.
MPI_BURST	I	Driven active low indicates that a burst transfer is in progress. Driven high indicates that the current transfer is not a burst.
MPI_BDIP	I	Active low "Burst Data in Process" is driven by a PowerPC processor. Asserted indicates that the second beat in front of the current one is requested by the master. Negated before the burst transfer ends to abort the burst data phase.

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
D14	PT15B	1	A15/MPI_ADDR29	PT25B	1	A15/MPI_ADDR29
D13	PT15A	1	A17/MPI_ADDR31	PT25A	1	A17/MPI_ADDR31
F12	PT13D	1	A19/MPI_TSI21	PT24D	1	A19/MPI_TSI21
F13	PT13C	1	A20/MPI_BDIP	PT24C	1	A20/MPI_BDIP
B12	PT11B	1	A18/MPI_TSI20	PT24B	1	A18/MPI_TSI20
B11	PT11A	1	MPI_TEA	PT24A	1	MPI_TEA
E12	PT10D	1	D14/MPI_DATA14	PT23D	1	D14/MPI_DATA14
D12	PT10C	1	DP1/MPI_PAR1	PT23C	1	DP1/MPI_PAR1
G10	PT9B	1	A21/MPI_BURST	PT23B	1	A21/MPI_BURST
G9	PT9A	1	D15/MPI_DATA15	PT23A	1	D15/MPI_DATA15
C10	A_VDDIB3_L	-		A_VDDIB3_L	-	
E9	VCC12	-		VCC12	-	
B10	A_HDINP3_L	-	PCS 360 CH 3 IN P	A_HDINP3_L	-	PCS 360 CH 3 IN P
B9	A_HDINN3_L	-	PCS 360 CH 3 IN N	A_HDINN3_L	-	PCS 360 CH 3 IN N
A10	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P
D9	VCC12	-		VCC12	-	
A9	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N
C9	A_VDDOB3_L	-		A_VDDOB3_L	-	
A8	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N
C8	A_VDDOB2_L	-		A_VDDOB2_L	-	
A7	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P
E8	VCC12	-		VCC12	-	
B8	A_HDINN2_L	-	PCS 360 CH 2 IN N	A_HDINN2_L	-	PCS 360 CH 2 IN N
B7	A_HDINP2_L	-	PCS 360 CH 2 IN P	A_HDINP2_L	-	PCS 360 CH 2 IN P
C7	A_VDDIB2_L	-		A_VDDIB2_L	-	
D8	VCC12	-		VCC12	-	
C6	A_VDDIB1_L	-		A_VDDIB1_L	-	
E7	VCC12	-		VCC12	-	
B6	A_HDINP1_L	-	PCS 360 CH 1 IN P	A_HDINP1_L	-	PCS 360 CH 1 IN P
B5	A_HDINN1_L	-	PCS 360 CH 1 IN N	A_HDINN1_L	-	PCS 360 CH 1 IN N
A6	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P
D7	VCC12	-		VCC12	-	
A5	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N
C5	A_VDDOB1_L	-		A_VDDOB1_L	-	
A4	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N
C4	A_VDDOB0_L	-		A_VDDOB0_L	-	
A3	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P
E6	VCC12	-		VCC12	-	
B4	A_HDINN0_L	-	PCS 360 CH 0 IN N	A_HDINN0_L	-	PCS 360 CH 0 IN N
B3	A_HDINP0_L	-	PCS 360 CH 0 IN P	A_HDINP0_L	-	PCS 360 CH 0 IN P
C3	A_VDDIB0_L	-		A_VDDIB0_L	-	
D6	VCC12	-		VCC12	-	
L5	NC	-		PL21A	7	
M5	NC	-		PL21B	7	
G2	NC	-		PL20A	7	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
L33	PL27B	7		PL35B	7	
M30	PL27C	7		PL35C	7	
N30	PL27D	7		PL35D	7	
M31	PL29A	7		PL37A	7	
N31	PL29B	7		PL37B	7	
P24	PL29C	7		PL37C	7	
R24	PL29D	7		PL37D	7	
M33	PL30A	7		PL42A	7	
N33	PL30B	7		PL42B	7	
U25	PL30C	7		PL42C	7	
T25	PL30D	7		PL42D	7	
L34	PL31A	7		PL43A	7	
M34	PL31B	7		PL43B	7	
P29	PL31C	7		PL43C	7	
R29	PL31D	7		PL43D	7	
N34	PL34A	7		PL46A	7	
P34	PL34B	7		PL46B	7	
R27	PL34C	7		PL46C	7	
T27	PL34D	7		PL46D	7	
R32	PL35A	7	PCLKT7_1	PL47A	7	PCLKT7_1
R31	PL35B	7	PCLKC7_1	PL47B	7	PCLKC7_1
U24	PL35C	7	PCLKT7_3	PL47C	7	PCLKT7_3
T24	PL35D	7	PCLKC7_3	PL47D	7	PCLKC7_3
P33	PL36A	7	PCLKT7_0	PL48A	7	PCLKT7_0
R33	PL36B	7	PCLKC7_0	PL48B	7	PCLKC7_0
T26	PL36C	7	PCLKT7_2	PL48C	7	PCLKT7_2
U26	PL36D	7	PCLKC7_2	PL48D	7	PCLKC7_2
T32	PL38A	6	PCLKT6_0	PL50A	6	PCLKT6_0
T31	PL38B	6	PCLKC6_0	PL50B	6	PCLKC6_0
U29	PL38C	6	PCLKT6_1	PL50C	6	PCLKT6_1
V29	PL38D	6	PCLKC6_1	PL50D	6	PCLKC6_1
T30	PL39A	6		PL51A	6	
U30	PL39B	6		PL51B	6	
U27	PL39C	6	PCLKT6_3	PL51C	6	PCLKT6_3
V27	PL39D	6	PCLKC6_3	PL51D	6	PCLKC6_3
R34	PL40A	6		PL52A	6	
T34	PL40B	6		PL52B	6	
U28	PL40C	6	PCLKT6_2	PL52C	6	PCLKT6_2
V28	PL40D	6	PCLKC6_2	PL52D	6	PCLKC6_2
V30	PL43A	6		PL55A	6	
W30	PL43B	6		PL55B	6	
W27	PL43C	6	VREF1_6	PL55C	6	VREF1_6
Y27	PL43D	6		PL55D	6	
T33	PL44A	6		PL56A	6	
U33	PL44B	6		PL56B	6	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
C2	VCCJ	-		VCCJ	-	
M9	TDO	-	TDO	TDO	-	TDO
L9	TMS	-		TMS	-	
D1	TCK	-		TCK	-	
C1	TDI	-		TDI	-	
J8	PROGRAMN	1		PROGRAMN	1	
K8	MPIIRQN	1	CFGIRQN/MPI_IRQ_N	MPIIRQN	1	CFGIRQN/MPI_IRQ_N
B2	CCLK	1		CCLK	1	
H9	RESP_URC	-		RESP_URC	-	
H10	VCC12	-		VCC12	-	
H8	A_REFCLKN_R	-		A_REFCLKN_R	-	
G8	A_REFCLKP_R	-		A_REFCLKP_R	-	
C3	VCC12	-		VCC12	-	
D3	A_VDDIB0_R	-		A_VDDIB0_R	-	
A3	A_HDINP0_R	-	PCS 3E0 CH 0 IN P	A_HDINP0_R	-	PCS 3E0 CH 0 IN P
B3	A_HDINN0_R	-	PCS 3E0 CH 0 IN N	A_HDINN0_R	-	PCS 3E0 CH 0 IN N
E5	VCC12	-		VCC12	-	
A4	A_HDOUTP0_R	-	PCS 3E0 CH 0 OUT P	A_HDOUTP0_R	-	PCS 3E0 CH 0 OUT P
F6	A_VDDOB0_R	-		A_VDDOB0_R	-	
B4	A_HDOUTN0_R	-	PCS 3E0 CH 0 OUT N	A_HDOUTN0_R	-	PCS 3E0 CH 0 OUT N
F7	A_VDDOB1_R	-		A_VDDOB1_R	-	
B5	A_HDOUTN1_R	-	PCS 3E0 CH 1 OUT N	A_HDOUTN1_R	-	PCS 3E0 CH 1 OUT N
E6	VCC12	-		VCC12	-	
A5	A_HDOUTP1_R	-	PCS 3E0 CH 1 OUT P	A_HDOUTP1_R	-	PCS 3E0 CH 1 OUT P
B6	A_HDINN1_R	-	PCS 3E0 CH 1 IN N	A_HDINN1_R	-	PCS 3E0 CH 1 IN N
A6	A_HDINP1_R	-	PCS 3E0 CH 1 IN P	A_HDINP1_R	-	PCS 3E0 CH 1 IN P
C6	VCC12	-		VCC12	-	
D4	A_VDDIB1_R	-		A_VDDIB1_R	-	
C7	VCC12	-		VCC12	-	
D5	A_VDDIB2_R	-		A_VDDIB2_R	-	
A7	A_HDINP2_R	-	PCS 3E0 CH 2 IN P	A_HDINP2_R	-	PCS 3E0 CH 2 IN P
B7	A_HDINN2_R	-	PCS 3E0 CH 2 IN N	A_HDINN2_R	-	PCS 3E0 CH 2 IN N
E7	VCC12	-		VCC12	-	
A8	A_HDOUTP2_R	-	PCS 3E0 CH 2 OUT P	A_HDOUTP2_R	-	PCS 3E0 CH 2 OUT P
F8	A_VDDOB2_R	-		A_VDDOB2_R	-	
B8	A_HDOUTN2_R	-	PCS 3E0 CH 2 OUT N	A_HDOUTN2_R	-	PCS 3E0 CH 2 OUT N
F9	A_VDDOB3_R	-		A_VDDOB3_R	-	
B9	A_HDOUTN3_R	-	PCS 3E0 CH 3 OUT N	A_HDOUTN3_R	-	PCS 3E0 CH 3 OUT N
E8	VCC12	-		VCC12	-	
A9	A_HDOUTP3_R	-	PCS 3E0 CH 3 OUT P	A_HDOUTP3_R	-	PCS 3E0 CH 3 OUT P
B10	A_HDINN3_R	-	PCS 3E0 CH 3 IN N	A_HDINN3_R	-	PCS 3E0 CH 3 IN N
A10	A_HDINP3_R	-	PCS 3E0 CH 3 IN P	A_HDINP3_R	-	PCS 3E0 CH 3 IN P
C10	VCC12	-		VCC12	-	
D6	A_VDDIB3_R	-		A_VDDIB3_R	-	
G10	VCC12	-		VCC12	-	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
E24	B_HDINP1_L	-	PCS 361 CH 1 IN P	B_HDINP1_L	-	PCS 361 CH 1 IN P
F24	B_HDINN1_L	-	PCS 361 CH 1 IN N	B_HDINN1_L	-	PCS 361 CH 1 IN N
A23	B_HDOUTP1_L	-	PCS 361 CH 1 OUT P	B_HDOUTP1_L	-	PCS 361 CH 1 OUT P
L25	VCC12	-		VCC12	-	
B23	B_HDOUTN1_L	-	PCS 361 CH 1 OUT N	B_HDOUTN1_L	-	PCS 361 CH 1 OUT N
D24	B_VDDOB1_L	-		B_VDDOB1_L	-	
B24	B_HDOUTN0_L	-	PCS 361 CH 0 OUT N	B_HDOUTN0_L	-	PCS 361 CH 0 OUT N
D25	B_VDDOB0_L	-		B_VDDOB0_L	-	
A24	B_HDOUTP0_L	-	PCS 361 CH 0 OUT P	B_HDOUTP0_L	-	PCS 361 CH 0 OUT P
K25	VCC12	-		VCC12	-	
F25	B_HDINN0_L	-	PCS 361 CH 0 IN N	B_HDINN0_L	-	PCS 361 CH 0 IN N
E25	B_HDINP0_L	-	PCS 361 CH 0 IN P	B_HDINP0_L	-	PCS 361 CH 0 IN P
D28	B_VDDIB0_L	-		B_VDDIB0_L	-	
G25	VCC12	-		VCC12	-	
D29	A_VDDIB3_L	-		A_VDDIB3_L	-	
C25	VCC12	-		VCC12	-	
A25	A_HDINP3_L	-	PCS 360 CH 3 IN P	A_HDINP3_L	-	PCS 360 CH 3 IN P
B25	A_HDINN3_L	-	PCS 360 CH 3 IN N	A_HDINN3_L	-	PCS 360 CH 3 IN N
A26	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P
E27	VCC12	-		VCC12	-	
B26	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N
F26	A_VDDOB3_L	-		A_VDDOB3_L	-	
B27	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N
F27	A_VDDOB2_L	-		A_VDDOB2_L	-	
A27	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P
E28	VCC12	-		VCC12	-	
B28	A_HDINN2_L	-	PCS 360 CH 2 IN N	A_HDINN2_L	-	PCS 360 CH 2 IN N
A28	A_HDINP2_L	-	PCS 360 CH 2 IN P	A_HDINP2_L	-	PCS 360 CH 2 IN P
D30	A_VDDIB2_L	-		A_VDDIB2_L	-	
C28	VCC12	-		VCC12	-	
D31	A_VDDIB1_L	-		A_VDDIB1_L	-	
C29	VCC12	-		VCC12	-	
A29	A_HDINP1_L	-	PCS 360 CH 1 IN P	A_HDINP1_L	-	PCS 360 CH 1 IN P
B29	A_HDINN1_L	-	PCS 360 CH 1 IN N	A_HDINN1_L	-	PCS 360 CH 1 IN N
A30	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P
E29	VCC12	-		VCC12	-	
B30	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N
F28	A_VDDOB1_L	-		A_VDDOB1_L	-	
B31	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N
F29	A_VDDOB0_L	-		A_VDDOB0_L	-	
A31	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P
E30	VCC12	-		VCC12	-	
B32	A_HDINN0_L	-	PCS 360 CH 0 IN N	A_HDINN0_L	-	PCS 360 CH 0 IN N
A32	A_HDINP0_L	-	PCS 360 CH 0 IN P	A_HDINP0_L	-	PCS 360 CH 0 IN P
D32	A_VDDIB0_L	-		A_VDDIB0_L	-	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AB15	VCC12	-		VCC12	-	
AB20	VCC12	-		VCC12	-	
N15	VCC12	-		VCC12	-	
N20	VCC12	-		VCC12	-	
R13	VCC12	-		VCC12	-	
R22	VCC12	-		VCC12	-	
Y13	VCC12	-		VCC12	-	
Y22	VCC12	-		VCC12	-	
AA12	VCCAUX	-		VCCAUX	-	
AA23	VCCAUX	-		VCCAUX	-	
AB12	VCCAUX	-		VCCAUX	-	
AB16	VCCAUX	-		VCCAUX	-	
AB17	VCCAUX	-		VCCAUX	-	
AB18	VCCAUX	-		VCCAUX	-	
AB19	VCCAUX	-		VCCAUX	-	
AB23	VCCAUX	-		VCCAUX	-	
AC12	VCCAUX	-		VCCAUX	-	
AC13	VCCAUX	-		VCCAUX	-	
Y19	GND	-		GND	-	
AC14	VCCAUX	-		VCCAUX	-	
AC17	VCCAUX	-		VCCAUX	-	
AC21	VCCAUX	-		VCCAUX	-	
AC22	VCCAUX	-		VCCAUX	-	
AC23	VCCAUX	-		VCCAUX	-	
M13	VCCAUX	-		VCCAUX	-	
M14	VCCAUX	-		VCCAUX	-	
M18	VCCAUX	-		VCCAUX	-	
M21	VCCAUX	-		VCCAUX	-	
M22	VCCAUX	-		VCCAUX	-	
N12	VCCAUX	-		VCCAUX	-	
N16	VCCAUX	-		VCCAUX	-	
N17	VCCAUX	-		VCCAUX	-	
N18	VCCAUX	-		VCCAUX	-	
N19	VCCAUX	-		VCCAUX	-	
N23	VCCAUX	-		VCCAUX	-	
P12	VCCAUX	-		VCCAUX	-	
P23	VCCAUX	-		VCCAUX	-	
T13	VCCAUX	-		VCCAUX	-	
T22	VCCAUX	-		VCCAUX	-	
U12	VCCAUX	-		VCCAUX	-	
U13	VCCAUX	-		VCCAUX	-	
U22	VCCAUX	-		VCCAUX	-	
V13	VCCAUX	-		VCCAUX	-	
V22	VCCAUX	-		VCCAUX	-	
V23	VCCAUX	-		VCCAUX	-	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
L21	PT55D	1	A16/MPI_ADDR30
L20	PT55C	1	D13/MPI_DATA13
D20	PT55B	1	A15/MPI_ADDR29
E20	PT55A	1	A17/MPI_ADDR31
L19	PT54D	1	A19/MPI_TSI_Z1
K19	PT54C	1	A20/MPI_BDIP
D21	PT54B	1	A18/MPI_TSI_Z0
E21	PT54A	1	MPI_TEA
M20	PT51D	1	D14/MPI_DATA14
M19	PT51C	1	DP1/MPI_PAR1
F21	PT51B	1	A21/MPI_BURST
G21	PT51A	1	D15/MPI_DATA15
H24	B_REFCLKP_L	-	
J24	B_REFCLKN_L	-	
L22	VCC12	-	
E26	B_VDDIB3_L	-	
G22	VCC12	-	
E22	B_HDINP3_L	-	PCS 361 CH 3 IN P
F22	B_HDINN3_L	-	PCS 361 CH 3 IN N
A21	B_HDOUTP3_L	-	PCS 361 CH 3 OUT P
L24	VCC12	-	
B21	B_HDOUTN3_L	-	PCS 361 CH 3 OUT N
D22	B_VDDOB3_L	-	
B22	B_HDOUTN2_L	-	PCS 361 CH 2 OUT N
D23	B_VDDOB2_L	-	
A22	B_HDOUTP2_L	-	PCS 361 CH 2 OUT P
K24	VCC12	-	
F23	B_HDINN2_L	-	PCS 361 CH 2 IN N
E23	B_HDINP2_L	-	PCS 361 CH 2 IN P
D26	B_VDDIB2_L	-	
G23	VCC12	-	
D27	B_VDDIB1_L	-	
G24	VCC12	-	
E24	B_HDINP1_L	-	PCS 361 CH 1 IN P
F24	B_HDINN1_L	-	PCS 361 CH 1 IN N
A23	B_HDOUTP1_L	-	PCS 361 CH 1 OUT P
L25	VCC12	-	
B23	B_HDOUTN1_L	-	PCS 361 CH 1 OUT N
D24	B_VDDOB1_L	-	
B24	B_HDOUTN0_L	-	PCS 361 CH 0 OUT N
D25	B_VDDOB0_L	-	
A24	B_HDOUTP0_L	-	PCS 361 CH 0 OUT P
K25	VCC12	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AF40	PL76A	6		PL90A	6	
AG40	PL76B	6		PL90B	6	
AG36	PL76C	6		PL90C	6	
AH36	PL76D	6	DIFFR_6	PL90D	6	DIFFR_6
AF39	PL77A	6		PL91A	6	
AG39	PL77B	6		PL91B	6	
AF29	PL77C	6		PL91C	6	
AG29	PL77D	6		PL91D	6	
AH42	PL78A	6		PL92A	6	
AG42	PL78B	6		PL92B	6	
AG35	PL78C	6		PL92C	6	
AH35	PL78D	6		PL92D	6	
AG41	PL80A	6		PL94A	6	
AH41	PL80B	6		PL94B	6	
AG34	PL80C	6		PL94C	6	
AH34	PL80D	6		PL94D	6	
AJ42	PL81A	6		PL96A	6	
AK42	PL81B	6		PL96B	6	
AG33	PL81C	6		PL96C	6	
AH33	PL81D	6		PL96D	6	
AJ41	PL82A	6		PL98A	6	
AK41	PL82B	6		PL98B	6	
AJ37	PL82C	6		PL98C	6	
AK37	PL82D	6		PL98D	6	
AJ40	PL84A	6		PL99A	6	
AK40	PL84B	6		PL99B	6	
AJ34	PL84C	6		PL99C	6	
AK34	PL84D	6		PL99D	6	
AJ38	PL85A	6		PL103A	6	
AK38	PL85B	6		PL103B	6	
AH32	PL85C	6		PL103C	6	
AJ32	PL85D	6		PL103D	6	
AL42	PL86A	6		PL104A	6	
AM42	PL86B	6		PL104B	6	
AK36	PL86C	6		PL104C	6	
AL36	PL86D	6		PL104D	6	
AL38	PL89A	6		PL107A	6	
AM38	PL89B	6		PL107B	6	
AJ33	PL89C	6		PL107C	6	
AK33	PL89D	6	VREF2_6	PL107D	6	VREF2_6
AN42	PL90A	6		PL109A	6	
AP42	PL90B	6		PL109B	6	
AH31	PL90C	6		PL109C	6	
AJ31	PL90D	6		PL109D	6	
AN41	PL91A	6		PL112A	6	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AE1	PR74A	3		PR88A	3	
AF12	PR73D	3		PR87D	3	
AE12	PR73C	3		PR87C	3	
AF2	PR73B	3		PR87B	3	
AE2	PR73A	3		PR87A	3	
AF11	PR72D	3		PR86D	3	
AE11	PR72C	3		PR86C	3	
AF5	PR72B	3		PR86B	3	
AE5	PR72A	3		PR86A	3	
AF10	PR69D	3		PR83D	3	
AE10	PR69C	3		PR83C	3	
AD1	PR69B	3		PR83B	3	
AC1	PR69A	3		PR83A	3	
AF9	PR68D	3		PR82D	3	
AE9	PR68C	3		PR82C	3	
AD2	PR68B	3		PR82B	3	
AC2	PR68A	3		PR82A	3	
AF6	PR67D	3		PR81D	3	
AE6	PR67C	3		PR81C	3	
AD3	PR67B	3		PR81B	3	
AC3	PR67A	3		PR81A	3	
AE8	PR65D	3		PR79D	3	
AD8	PR65C	3		PR79C	3	
AD4	PR65B	3		PR79B	3	
AC4	PR65A	3		PR79A	3	
AE7	PR64D	3		PR78D	3	
AD7	PR64C	3		PR78C	3	
AD5	PR64B	3		PR78B	3	
AC5	PR64A	3		PR78A	3	
AD6	PR63D	3		PR77D	3	
AC6	PR63C	3		PR77C	3	
AB1	PR63B	3		PR77B	3	
AA1	PR63A	3		PR77A	3	
AD9	PR61D	3		PR75D	3	
AC9	PR61C	3		PR75C	3	
AB2	PR61B	3		PR75B	3	
AA2	PR61A	3		PR75A	3	
AD14	PR60D	3		PR74D	3	
AC14	PR60C	3		PR74C	3	
AB5	PR60B	3		PR74B	3	
AA5	PR60A	3		PR74A	3	
AD10	PR59D	3		PR73D	3	
AC10	PR59C	3		PR73C	3	
Y1	PR59B	3		PR73B	3	
W1	PR59A	3		PR73A	3	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
A26	D_HDOUTN2_L	-	PCS 363 CH 2 OUT N	D_HDOUTN2_L	-	PCS 363 CH 2 OUT N
C34	D_VDDOB2_L	-		D_VDDOB2_L	-	
B26	D_HDOUTP2_L	-	PCS 363 CH 2 OUT P	D_HDOUTP2_L	-	PCS 363 CH 2 OUT P
C32	VCC12	-		VCC12	-	
E27	D_HDINN2_L	-	PCS 363 CH 2 IN N	D_HDINN2_L	-	PCS 363 CH 2 IN N
D27	D_HDINP2_L	-	PCS 363 CH 2 IN P	D_HDINP2_L	-	PCS 363 CH 2 IN P
G25	D_VDDIB2_L	-		D_VDDIB2_L	-	
F29	VCC12	-		VCC12	-	
H26	D_VDDIB1_L	-		D_VDDIB1_L	-	
F30	VCC12	-		VCC12	-	
D28	D_HDINP1_L	-	PCS 363 CH 1 IN P	D_HDINP1_L	-	PCS 363 CH 1 IN P
E28	D_HDINN1_L	-	PCS 363 CH 1 IN N	D_HDINN1_L	-	PCS 363 CH 1 IN N
B27	D_HDOUTP1_L	-	PCS 363 CH 1 OUT P	D_HDOUTP1_L	-	PCS 363 CH 1 OUT P
F36	VCC12	-		VCC12	-	
A27	D_HDOUTN1_L	-	PCS 363 CH 1 OUT N	D_HDOUTN1_L	-	PCS 363 CH 1 OUT N
F35	D_VDDOB1_L	-		D_VDDOB1_L	-	
A28	D_HDOUTN0_L	-	PCS 363 CH 0 OUT N	D_HDOUTN0_L	-	PCS 363 CH 0 OUT N
M30	D_VDDOB0_L	-		D_VDDOB0_L	-	
B28	D_HDOUTP0_L	-	PCS 363 CH 0 OUT P	D_HDOUTP0_L	-	PCS 363 CH 0 OUT P
F37	VCC12	-		VCC12	-	
E29	D_HDINN0_L	-	PCS 363 CH 0 IN N	D_HDINN0_L	-	PCS 363 CH 0 IN N
D29	D_HDINP0_L	-	PCS 363 CH 0 IN P	D_HDINP0_L	-	PCS 363 CH 0 IN P
H27	D_VDDIB0_L	-		D_VDDIB0_L	-	
G28	VCC12	-		VCC12	-	
J28	C_REFCLKP_L	-		C_REFCLKP_L	-	
K28	C_REFCLKN_L	-		C_REFCLKN_L	-	
F32	VCC12	-		VCC12	-	
G29	C_VDDIB3_L	-		C_VDDIB3_L	-	
C31	VCC12	-		VCC12	-	
D30	C_HDINP3_L	-	PCS 362 CH 3 IN P	C_HDINP3_L	-	PCS 362 CH 3 IN P
E30	C_HDINN3_L	-	PCS 362 CH 3 IN N	C_HDINN3_L	-	PCS 362 CH 3 IN N
B29	C_HDOUTP3_L	-	PCS 362 CH 3 OUT P	C_HDOUTP3_L	-	PCS 362 CH 3 OUT P
F38	VCC12	-		VCC12	-	
A29	C_HDOUTN3_L	-	PCS 362 CH 3 OUT N	C_HDOUTN3_L	-	PCS 362 CH 3 OUT N
J33	C_VDDOB3_L	-		C_VDDOB3_L	-	
A30	C_HDOUTN2_L	-	PCS 362 CH 2 OUT N	C_HDOUTN2_L	-	PCS 362 CH 2 OUT N
K33	C_VDDOB2_L	-		C_VDDOB2_L	-	
B30	C_HDOUTP2_L	-	PCS 362 CH 2 OUT P	C_HDOUTP2_L	-	PCS 362 CH 2 OUT P
J34	VCC12	-		VCC12	-	
F31	C_HDINN2_L	-	PCS 362 CH 2 IN N	C_HDINN2_L	-	PCS 362 CH 2 IN N
E31	C_HDINP2_L	-	PCS 362 CH 2 IN P	C_HDINP2_L	-	PCS 362 CH 2 IN P
G30	C_VDDIB2_L	-		C_VDDIB2_L	-	
H28	VCC12	-		VCC12	-	
C37	C_VDDIB1_L	-		C_VDDIB1_L	-	
H30	VCC12	-		VCC12	-	

Commercial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA80E-7FC1152C ¹	-7	Ceramic fcBGA	1152	COM	80.1
LFSC3GA80E-6FC1152C ¹	-6	Ceramic fcBGA	1152	COM	80.1
LFSC3GA80E-5FC1152C ¹	-5	Ceramic fcBGA	1152	COM	80.1
LFSC3GA80E-7FF1152C	-7	Organic fcBGA	1152	COM	80.1
LFSC3GA80E-6FF1152C	-6	Organic fcBGA	1152	COM	80.1
LFSC3GA80E-5FF1152C	-5	Organic fcBGA	1152	COM	80.1
LFSC3GA80E-7FC1704C ¹	-7	Ceramic fcBGA	1704	COM	80.1
LFSC3GA80E-6FC1704C ¹	-6	Ceramic fcBGA	1704	COM	80.1
LFSC3GA80E-5FC1704C ¹	-5	Ceramic fcBGA	1704	COM	80.1
LFSC3GA80E-7FF1704C	-7	Organic fcBGA	1704	COM	80.1
LFSC3GA80E-6FF1704C	-6	Organic fcBGA	1704	COM	80.1
LFSC3GA80E-5FF1704C	-5	Organic fcBGA	1704	COM	80.1

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA80EP1-7FC1152C ¹	-7	Ceramic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-6FC1152C ¹	-6	Ceramic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-5FC1152C ¹	-5	Ceramic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-7FF1152C	-7	Organic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-6FF1152C	-6	Organic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-5FF1152C	-5	Organic fcBGA	1152	COM	80.1
LFSCM3GA80EP1-7FC1704C ¹	-7	Ceramic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-6FC1704C ¹	-6	Ceramic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-5FC1704C ¹	-5	Ceramic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-7FF1704C	-7	Organic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-6FF1704C	-6	Organic fcBGA	1704	COM	80.1
LFSCM3GA80EP1-5FF1704C	-5	Organic fcBGA	1704	COM	80.1

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA115E-6FC1152C ¹	-6	Ceramic fcBGA	1152	COM	115.2
LFSC3GA115E-5FC1152C ¹	-5	Ceramic fcBGA	1152	COM	115.2
LFSC3GA115E-6FF1152C	-6	Organic fcBGA	1152	COM	115.2
LFSC3GA115E-5FF1152C	-5	Organic fcBGA	1152	COM	115.2
LFSC3GA115E-6FC1704C ¹	-6	Ceramic fcBGA	1704	COM	115.2
LFSC3GA115E-5FC1704C ¹	-5	Ceramic fcBGA	1704	COM	115.2
LFSC3GA115E-6FF1704C	-6	Organic fcBGA	1704	COM	115.2
LFSC3GA115E-5FF1704C	-5	Organic fcBGA	1704	COM	115.2

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).

Commercial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA115EP1-6FC1152C ¹	-6	Ceramic fcBGA	1152	COM	115.2
LFSCM3GA115EP1-5FC1152C ¹	-5	Ceramic fcBGA	1152	COM	115.2
LFSCM3GA115EP1-6FF1152C	-6	Organic fcBGA	1152	COM	115.2
LFSCM3GA115EP1-5FF1152C	-5	Organic fcBGA	1152	COM	115.2
LFSCM3GA115EP1-6FC1704C ¹	-6	Ceramic fcBGA	1704	COM	115.2
LFSCM3GA115EP1-5FC1704C ¹	-5	Ceramic fcBGA	1704	COM	115.2
LFSCM3GA115EP1-6FF1704C	-6	Organic fcBGA	1704	COM	115.2
LFSCM3GA115EP1-5FF1704C	-5	Organic fcBGA	1704	COM	115.2

1. Converted to organic flip-chip BGA package per [PCN #01A-10](#).